BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS045045006-SF-15E

Description: 45.00 x 45.00 x 6.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin
Heat Sink Attachment: superGRIP
Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

| AIR VELOCITY | | @200 LFM 1.0 M/S | @300 LFM 1.5 M/S | @400 LFM 2.0 M/S | @500 LFM 2.5 M/S | @600 LFM 3.0 M/S | @700 LFM 3.5 M/S | @800 LFM 4.0 M/S |
|--------------------|---------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| THERMAL RESISTANCE | Unducted Flow | 14.09 °C/W | 8.6 °C/W | 6.1 °C/W | 4.8 °C/W | 4.1 °C/W | 3.6 °C/W | 3.3 °C/W |
| | Ducted Flow | 3.4 | 2.8 | 2.4 | 2.2 | 2 | 1.9 | 1.8 |

Product Detail



